(Filing Date)

## Declaration For U.S. Patent Application

#3

As a below named inventor, I hereby declare that: OCT 0 2 2001

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled (Insert Title) METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES

the specification of which is attached hereto unless the following is checked:

	was filed onJune 28, 2001	as United States Application Number or PCT Internationa	
X	Application Number 09/892,893	and was amended on	
	(if applicable)		

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

(List prior foreign	Pat. Appln. No. 2000-201248 (Number)	Japan (Country)	03 / 07 / 2000 (Day/Month/Year Filed)	Priority Claimed _ 2 Yes 1 No		
applications. See note A on back of	(Number)	(Country)	(Day/Month/Year Filed)	_		
this page)	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No		
	(Number)	(Country)	(Day/Month/Year Filed)			
(See note B on back of this page)						
I hereby claim the ber	nefit under Title 35, United State	s Code, § 119(e) of any United	States provisional application(s) l	isted below.		
				<del></del>		
	(Application Nu	imber)	(Filing Date)			

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the application:

(Application Number)

(List Prior U.S. Applications)	(Application Serial Number)	(Filing Date)	(Status) (patented, pending, abandoned)
	(Application Serial Number)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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1

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of	fourth inventor (given name, family name)			
Inventor's Sig	gnature	Date		
Residence		Citizenship _		
Post Office A	ddress			
Full name of	fifth inventor (given name, family name)		•	
Inventor's Sig	gnature	Date	· · · · · · · · · · · · · · · · · · ·	
Residence		Citizenship		
Post Office A	ddress	· · · · · · · · · · · · · · · · · · ·		
Full name of s	sixth inventor (given name, family name)			
	gnature			
Residence		Citizenship		
Post Office Ad	ddress	· · · · · · · · · · · · · · · · · · ·	<del></del>	
Full name of s	seventh inventor (given name, family name)			
Inventor's Sig	gnature	Date		
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	eighth inventor (given name, family name)			
	nature			
	ddress			